PUA3121 (PU3121)

Silicon NPN triple diffusion planar type darlington

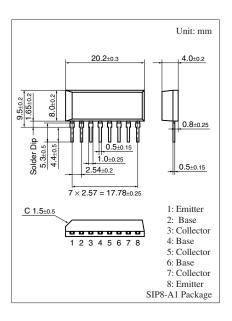
For power amplification

■ Features

- Built-in zener diode (30 V) between collector and base
- Small variation in withstand pressure
- Large energy handling capability
- High-speed switching
- NPN 3 elements

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open) V _{CBO}	30±5	V
Collector-emitter voltage (Base open)	V _{CEO}	30±5	V
Emitter-base voltage (Collector open)	V _{EBO}	5	V
Collector current	I_{C}	2	A
Peak collector current	I_{CP}	4	A
Collector power dissipation	P _C	15	W
$T_a = 25^{\circ}C$	2	2.4	
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C



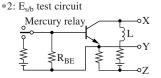
■ Electrical Characteristics $T_C = 25$ °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V _{CEO}	$I_C = 5 \text{ mA}, I_B = 0$	25		35	V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 25 \text{ V}, I_{E} = 0$			100	μΑ
Emitter-base cutoff current (Collector open)	I_{EBO}	$V_{EB} = 5 \text{ V}, I_{C} = 0$			2	mA
Forward current transfer ratio	h _{FE1}	$V_{CE} = 4 \text{ V}, I_{C} = 1 \text{ A}$	1 000			_
	h _{FE2} *1	$V_{CE} = 4 \text{ V}, I_{C} = 2 \text{ A}$	1 000		10 000	
Collector-emitter saturation voltage	V _{CE(sat)}	$I_C = 2 \text{ A}, I_B = 8 \text{ mA}$			2.5	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_C = 2 \text{ A}, I_B = 8 \text{ mA}$			2.5	V
Transition frequency	f_T	$V_{CE} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time	t _{on}	$I_C = 2 A$		0.4		μs
Storage time	t _{stg}	$I_{B1} = 8 \text{ mA}, I_{B2} = -8 \text{ mA}$		3.0		μs
Fall time	t _f	$V_{CC} = 20 \text{ V}$		1.0		μs
Energy handling capability *2	E _{s/b}	$I_C = 1.45 \text{ A}, L = 100 \text{ mH}, R_{BE} = 100 \Omega$	100			mJ

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

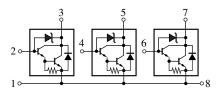
2. *1: Rank classification

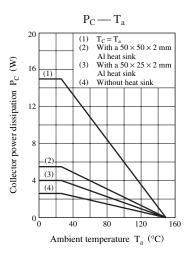
Rank	Free	Р	Q	
h_{FE}	1000 to 10000	2000 to 10000	1000 to 5000	

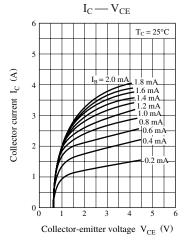


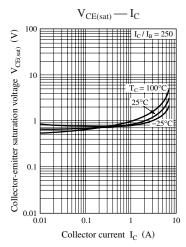
Note) The part numbers in the parenthesis show conventional part number.

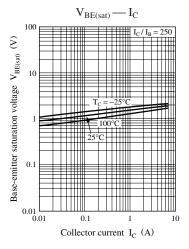
■ Internal Connection

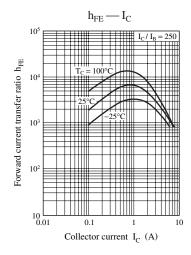


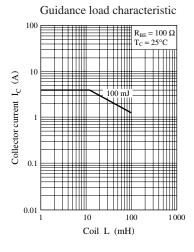


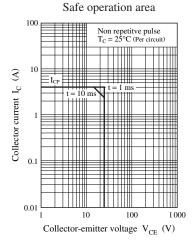












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